

# SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER: (客戶):志盛翔

DATE: (日期):2017-06-08

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: GT 25V220μF(φ6.3X11)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPL	IER	CUS	ГОМЕR
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
李婷	刘渭清		

## ELECTROLYTIC CAPACITOR SPECIFICATION GT SERIES

		SPECIFICAT	ALTERNATION HISTORY RECORDS				
Rev.	Date	GT SERIE Mark	ES Page	Contents	Purpose	Drafter	Approver
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MAN YUE ELECTRONICS COMPANY LIMITED			ELECTROLYTIC CAPACITOR SPECIFICATION GT SERIES				_			SAM	XO	Ν		
Tab	le 1 Product Dimen	sions a	nd Ch	aracteristic	28						Unit	: mm		
	Safety vent for $\geq \Phi$ 6.3		5 min	$\phi d \pm 0.05$	5 -		F±0.5	β	L<20:α=1.5 ΦD<20:β is flat rubb surface.	=0.5; ΦD	≥20 : β=1.		n the f	lat rubber
N 0.	SAMXON Part No.	WV (Vdc)	Cap. (µF )	Cap. tolerance	Temp. range(°C)	tanδ (120Hz, 20℃)	Leakage Current (µA,2min)	Max Ripple Current at 105℃ 100KHz (mA rms)	Impedance at 20°C 100KHz (Ωmax)	Load lifetime (Hrs)		ension (mm) F	фd	Sleeve

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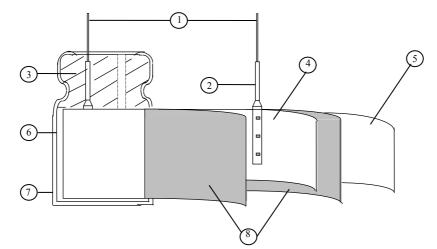
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	SERIES	_		CE TOL		VOLTAGE	-	CASE	SIZE	TYP			SLEEV
												PRODUCT LINE N	
	Series ESM	Cap(MFD)	Code	Tolerance (%)	Code	Voltage (W.V.) 2	Code 0D	Case S		Feature (		SAMXON Product L For internal use only	
	EKF ESS	0.1	104	±5	J.	2.5	0E	3.5	B 1	Radial bulk	RR	(The product lines	
	EKS EGS EKM	0.22	224	±10	к	4 6.3	0G 0J	4 5 6.3	Ċ D E	Ammo Tap	ing	we have H,A,B,C,D, E,M or 0,1,2,3,4,5,9	
	EKG	0.33	334			8	0K 1A	8	F G	2.0mm Pitch	тт		
	EZM EZS	0.47	474	±15	L	12.5	1B	12.5 13 13.5	J	2.5mm Pitch	τu		
	EGF ESF EGT	1	105	±20	м	16 20	1C 1D	13.5	4	3.5mm Pitch	тν	Sleeve Material	Code
	EGK	2.2	225		N	25 30	1E 1I	16 16.5	<u>к</u> 7	5.0mm Pitch	тс	PET	Р
	EGD EGC			±30		32	13 1V	18 18.5 20	L 8 M N	Lead Cut & F			
	ERS ERF ERL	3.3	335	-40 0	w	35 40	1G	20 22 25	N				
		4.7	475	-20	A	42 50	1M 1H	25 30 34 35	P W	СВ-Туре	СВ		
	ERE	10	106	-		57	1L	35	R	CE-Type	CE		
	EBD	22	226	-20 +10	С	63 71	1J 1S	40 42 45 51	OPWQR46ST	HE-Type	HE		
	ERA ERB ERC	33	336	-20 +40	×	75 80	1 <b>T</b> 1K	63.5 76	T U 8	КД-Туре	кD		
	EFA	47	476	-20 +50	s	85	1R 19	80 90 100	8 X Z	FD-Type	FD		
	ENH	47		-10		90 100	2A	Len.(mm) 4.5	Code	EH-Type	ЕН		
	ERY ELP EAP	100	107	Ö	В	120 125	20 2B	5 5.4	05 54 07				
	EQP	220	227	-10 +20	v	150 160	2Z 2C	7_7 7_7 10.2	07 77 T2	PCB Term			
	ETP	330	337	-10 +30	Q	180	2P	11.5	11 1A		sw		
	EUP EKP EEP	470	477	-10	т	200	2D 22	12 12.5	12 1B	Snap-in	sx		
	EFP	2200	228	+50		220 230	2N 23	13 13.5 20	13 1C 20		sz		
	EGP	22000	229	-5 +10	E	250	2E	20 25 29.5	25 2J	Lug	SG		
	EWR EWU EWT			-5 +15	F	275	2T 2I	30 31.5	30 3A		05		
	EWX	33000	339	-5 +20	G	310	2R	35 35.5 50	35 3E 50		06		
	EWS	47000	479	0	R	315 330	2F 2U	100	50 80 1L				
	EWL EWB VSS	100000	10T	+20	0	350 360	2V 2X	105 110	1K 1M	Screw	т5		
	VNS VKS	150000	15T	+30		375 385	2Q 2Y	120 130 140	1P		т6		
	VKM VRL	220000	22T	+50	1	400	2G	150 155	1R 1E		<b>D</b> 5		
	VNH VZS VRF	330000	33Т	+5 +15	z	420	2M 2W	160 165	1 <u>S</u> 1F		D6		
	VKP			+5 +20	D	500 550	2H 25	170 180 190	1U 1V				
		1000000	10M	+10 +50	Y	600	26						
		1500000	15M	+10	н	630	2J	200 215 210 220 240	2M 2N				
		2200000	22M	+30				250	20 2R 28				
		3300000	33M					270	2T				
Ľ													

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#### 3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



	Component	Material
1	Lead line	Tinned CP wire (Pb Free)
2	Terminal	Aluminum wire
3	Sealing Material	Rubber
4	Al-Foil (+)	Formed aluminum foil
5	Al-Foil (-)	Etched aluminum foil or formed aluminum foil
6	Case	Aluminum case
7	Sleeve	РЕТ
8	Separator	Electrolyte paper

## 4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:

Ambient temperature	$: 20^{\circ}C \pm 2^{\circ}C$
Relative humidity	: 60% to 70%
Air Pressure	: 86kPa to 106kPa

#### Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2.

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	e 2 ITEM				PERFC	RMANC	Ъ.			
	Rated				T LIU C					
	voltage (WV)	WV (V.DC)	6.3	10	16	25	35	50	63	100
4.1		SV (V.DC)	8	13	20	32	44	63	79	125
	Surge voltage (SV)									
4.2	Nominal capacitance (Tolerance)	<condition> Measuring F Measuring V Measuring T <criteria> Shall be with</criteria></condition>	requency oltage emperat	: N Ture : 20	)±2℃	than 0.5V				
4.3	Leakage current	<condition> Connecting t minutes, and <criteria> Refer to Table</criteria></condition>	the capac then, me				istor (1	$ \mathbf{k}  \Omega \pm 10$	Ω) in s	eries for 2
4.4	tan δ	<condition> See 4.2, Norr <criteria> Refer to Table</criteria></condition>	m Capac	itance, fo	or measur	ring frequ	iency, vo	oltage and	l tempera	ature.
4.5	Terminal strength	0.5r	ength of capacitor rength of apacitor,	r, applied f Termina applied f onds, and d wire less	force to lls. force to b then ber Tens	ent the te	rminal ( 0° to its	1~4 mm original Bending (k	from the position ; force N gf) 0.25)	rubber) for

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		<condition> STEP</condition>	Tecti	ng Tempo	erature(°C)			Time		
		<u> </u>	10511	$20\pm 2$			Time to reach thermal equilibrium			
		2						_		
		3		$\frac{-40(-23)}{20\pm 2}$				o reach thermal equilibrium		
		4		$\frac{20 \pm 2}{105 \pm 105 \pm $				thermal e	•	
		5		$\frac{105 \pm 20 \pm 2}{20 \pm 2}$				thermal e		
		<criteria></criteria>		20 - 2	2	Time			quinon	um
4.6	Temperature characteristi cs	a. $\tan \delta$ shall more than 8 tin b. In step 5, t more than the c. At-40 °C (-2 table.	mes of i an $\delta$ sha specifie	ts specifie all be with d value.	ed value. hin the lin	nit of Iter	n 4.4The	leakage	current	shall not
		Working Voltag	re (V)	6.3	10	16	25	35	50	63
		$Z-25^{\circ}C/Z+2$		4	3	2	23	2	2	2
		$Z-40^{\circ}C/Z+20$		8	6	4	3	3	3	3
				0			5	5	5	5
		Working Voltag		100	-					
		Z-25°C/Z+20		2						
		Z-40°C/Z+20		3	]					
		For capacitance	e value	> 1000 µ		-				
						-			Z-40°C/2	Z+20°C.
		Capacitance, tar <condition> According to II</condition>		-	nce shall b	e measur	ed at 120	Hz.		
4.7	Load life test	<condition>According to II<math>105^{\circ}C \pm 2</math> withDC and rippleproduct shouldresult should m<criteria>The characteriLeakageCapacitatan <math>\delta</math></criteria></condition>	EC6038 h DC bi be peak w be testaneet the stic sha curren ance Ch	4-4No.4. as voltage voltage sh ed after 16 following Il meet th t	13 method e plus the r hall not ex 6 hours red g table: <u>e followin</u> Value in Within <u>+</u>	e measur ls, The ca ated ripp cceed the covering t g require 4.3 shall 25% of e than 200	ed at 120 pacitor is le curren rated w ime at at <u>ments.</u> be satisfi initial va 0% of the	Hz. s stored a t for Tab orking v mospher ied alue. e specifie	t a temp ole 1. (T voltage) ic condi	berature of the sum of Then the tions. The
4.7	life	$<$ Condition>According to II105°C $\pm 2$ withDC and rippleproduct shouldresult should m $<$ Criteria>The characteriLeakageCapacita	EC6038 h DC bi be peak w be testaneet the stic sha curren ance Ch	4-4No.4. as voltage voltage sh ed after 16 following Il meet th t	13 method 13 method e plus the r fall not ez 6 hours red g table: e followin Value in Within <u>+</u>	e measur ls, The ca ated ripp cceed the covering t g require 4.3 shall 25% of e than 200	ed at 120 pacitor is le curren rated w ime at at <u>ments.</u> be satisfi initial va 0% of the	Hz. s stored a t for Tab orking v mospher ied alue. e specifie	t a temp ole 1. (T voltage) ic condi	berature of the sum of Then the tions. The

		<criteria></criteria>	d. 0.11
		The characteristic shall meet	Value in 4.3 shall be satisfied
	Shelf	Leakage current	
4.8	life	Capacitance Change	Within $\pm 25\%$ of initial value.
1.0	test	tan δ	Not more than 200% of the specified value.
		Appearance	There shall be no leakage of electrolyte.
			stored more than 1 year, the leakage current may
			e through about 1 k $\Omega$ resistor, if necessary.
			e 15~35℃.
4.9	Surge	Leakage current	Not more than the specified value.
т.)	test	Capacitance Change	Within $\pm 15\%$ of initial value.
		$\tan \delta$	Not more than the specified value.
			There shall be no leakage of electrolyte.
		Appearance Attention:	There shall be no leakage of electrolyte.
		over voltage as often applied <a href="https://www.commonstations.com"></a> Condition> The following conditions shaperpendicular directions. Vibration frequency ratio	all be applied for 2 hours in each 3 mutually
		Peak to peak amplitude Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	e : 1.5mm : 10Hz ~ 55Hz ~ 10Hz in about 1 minute greater than 12.5mm or longer than 25mm must be fixed
		Sweep rate Mounting method: The capacitor with diameter g	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute
		Sweep rate Mounting method: The capacitor with diameter g	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
4.10	Vibration	Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
4.10	Vibration test	Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	: $10Hz \sim 55Hz \sim 10Hz$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30°
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket.	: $10$ Hz ~ $55$ Hz ~ $10$ Hz in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within $30^{\circ}$
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les	: $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30° s To be soldered
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les 4mm or les Criteria> After the test, the following in Inner construction	: $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30° Solution of the soldered To be soldered tems shall be tested: No intermittent contacts, open or short circuiting.
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les 4mm or les Criteria> After the test, the following in Inner construction	: $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30° s within 30° To be soldered tems shall be tested: No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes.
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les	: $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed within 30° s s s s s s d tems shall be tested: No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes. No mechanical damage in terminal. No leakage
4.10		Sweep rate Mounting method: The capacitor with diameter g in place with a bracket. 4mm or les	: $10\text{Hz} \sim 55\text{Hz} \sim 10\text{Hz}$ in about 1 minute greater than 12.5mm or longer than 25mm must be fixed Within 30° s within 30° To be soldered tems shall be tested: No intermittent contacts, open or short circuiting. No damage of tab terminals or electrodes.

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4.11	Solderability test	<condition>         The capacitor shall be tested under the following conditions:         Soldering temperature       : 245±3°C         Dipping depth       : 2mm         Dipping speed       : 25±2.5mm/s         Dipping time       : 3±0.5s         <criteria>       A minimum of 95% of the surface being immersed</criteria></condition>
4.12	Resistance to solder heat test	<condition>Terminals of the capacitor shall be immersed into solder bath at <math>260 \pm 5^{\circ}</math>C for <math>10 \pm 180^{\circ}</math> C for <math>3^{+1}_{-0}</math> seconds to <math>1.5 \sim 2.0</math> mm from the body of capacitor.Then the capacitor shall be left under the normal temperature and normal humidity for <math>1 \sim 2</math> hours before measurement.Criteria&gt;Leakage currentNot more than the specified value.Capacitance ChangeWithin <math>\pm 10\%</math> of initial value.tan <math>\delta</math>Not more than the specified value.AppearanceThere shall be no leakage of electrolyte.</condition>
4.13	Change of temperature test	<condition>Temperature Cycle:According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below:</condition>
4.14	Damp heat test	<condition> Humidity Test: According to IEC60384-4No.4.12 methods, capacitor shall be exposed for <math>500 \pm 8</math> hours in an atmosphere of <math>90 \sim 95\%</math>R H .at <math>40 \pm 2</math>°C, the characteristic change shall meet the following requirement.<criteria>Leakage currentNot more than the specified value. Capacitance Change Within <math>\pm 20\%</math> of initial value. tan <math>\delta</math> Not more than 120% of the specified value.Image: tan <math>\delta</math> AppearanceNot more than 120% of the specified value.</criteria></condition>

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4.15	Vent test	<condition>         The following test only apply to those products with vent products at diameter <math>\geq \emptyset 6.3</math> with vent.         D.C. test         The capacitor is connected with its polarity reversed to a DC power source. Then a current selected from below table is applied.         <table 3="">         Diameter (mm)       DC Current (A)         22.4 or less       1         Over 22.4       10          Criteria&gt;         The vent shall operate with no dangerous conditions such as flames or dispersion of pieces of the capacitor and/or case.</table></condition>
4.16	Maximum permissible (ripple current)	Condition> The maximum permissible ripple current is the maximum A.C current at 120Hz and can be applied at maximum operating temperature Table-1 The combined value of D.C voltage and the peak A.C voltage shall not exceed the rated voltage and shall not reverse voltage. Frequency Multipliers: Coefficient (Hz) 50 120 300 1k 100k 100k 100 1.00

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# 5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances			
	Cadmium and cadmium compounds			
Heavy metals	Lead and lead compounds			
fieuv y filetais	Mercury and mercury compounds			
	Hexavalent chromium compounds			
	Polychlorinated biphenyls (PCB)			
Chloinated	Polychlorinated naphthalenes (PCN)			
organic	Polychlorinated terphenyls (PCT)			
compounds	Short-chain chlorinated paraffins(SCCP)			
	Other chlorinated organic compounds			
Duraniastal	Polybrominated biphenyls (PBB)			
Brominated	Polybrominated diphenylethers(PBDE) (including			
organic	decabromodiphenyl ether[DecaBDE])			
compounds	Other brominated organic compounds			
Tributyltin comp	pounds(TBT)			
Triphenyltin con	npounds(TPT)			
Asbestos				
Specific azo con	npounds			
Formaldehyde				
Beryllium oxide				
Beryllium copp	ber			
Specific phthalat	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)			
Hydrofluorocarb	oon (HFC), Perfluorocarbon (PFC)			
Perfluorooctane	sulfonates (PFOS)			
Specific Benzotr	riazole			

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#### **Attachment: Application Guidelines**

#### **1.Circuit Design**

- 1.1 Operating Temperature and Frequency
  - Electrolytic capacitor electrical parameters are normally specified at 20°C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.
- (1) Effects of operating temperature on electrical parameters
   a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
   b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
  - a) At higher frequencies capacitance and impedance decrease while tanδ increases.
  - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy

See the file: Life calculation of aluminum electrolytic capacitor

1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

#### (1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

#### 1.5 Capacitor Mounting Considerations

(1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board.

When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

(4) Clearance for Case Mounted Pressure Relief vents

Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.

φ6.3~φ16mm:2mm minimum, φ18~φ35mm:3mm minimum, φ40mm or greater:5mm minimum.

(5) Clearance for Seal Mounted Pressure Relief Vents

A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.

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(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite. (7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short. (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification. 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths (2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths. 1.7 The Product endurance should take the sample as the standard. 1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling. 1.9 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures. CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure. 2.Capacitor Handling Techniques 2.1 Considerations Before Using (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment. (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about  $1k\Omega$ . (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately  $1k\Omega$ . (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors. (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result. 2.2 Capacitor Insertion (1) Verify the correct capacitance and rated voltage of the capacitor. (2) Verify the correct polarity of the capacitor before inserting. (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals. (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor. For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection. 2.3 Manual Soldering (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 °C for 3 seconds or less. (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal. (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads. (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve. 2.4 Flow Soldering (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result. (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.

- (3) Do not allow other parts or components to touch the capacitor during soldering.
- 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve. For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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- 2.6 Capacitor Handling after Solder
- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.
- 2.7 Circuit Board Cleaning

Acetone

- Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- (2) Avoid using the following solvent groups unless specifically allowed for in the specification;

Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.

- Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- Xylene : deterioration of the rubber seal could result.
  - : removal of the ink markings on the vinyl sleeve could result.
- (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor. Please consult us for additional information about acceptable cleaning solvents or cleaning methods.
- 2.8 Mounting Adhesives and Coating Agents
  - When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers. After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

#### 3. Precautions for using capacitors

- 3.1 Environmental Conditions
  - Capacitors should not be stored or used in the following environments.
- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

**3.2 Electrical Precautions** 

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

#### 4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.
- If electrolyte or gas is ingested by month, gargle with water.
  - If electrolyte of gas is ingested by month, gargie with water.

#### 5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail. After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000 $\Omega$ , current limiting resistor for a time period of 30 minutes. If the expired date of products date code is over eighteen months, the products should be return to confirmation.

5.1 Environmental Conditions

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The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

#### 6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.